

Notice of Allowance dated 12/13/2007

Appl. No. 10/525,996

Amdt. dated February 25, 2008

Attorney Docket No. 1217-050618

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/525,996 Confirmation No. 6221
Applicants : Hideo SENOO et al.
Filed : February 28, 2005
Title : Semiconductor Wafer Protection Structure and Laminated
Protective Sheet For Use Therein
Art Unit : 2811
Examiner : Cuong Quang Nguyen
Customer No. : 28289

MAIL STOP ISSUE FEE

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

RESPONSE TO PTO COMMUNICATION RE INFORMATION DISCLOSURE STATEMENT

Sir:

A Notice of Allowance issued in the above-identified application on December 13, 2007. Upon final review of the prosecution history, it was noted that Applicants' Information Disclosure Statement filed May 3, 2006, had not been initialed and returned by the Examiner. A check of the records on Private PAIR indicated that the IDS had been received and scanned into PAIR on May 9, 2006. On January 3, 2008, Applicants faxed a copy of the May 3, 2006 Form PTO/SB/08a and requested that the Examiner initial and return a copy of the form to complete our records.

On February 14, 2008, the PTO issued an Office Communication indicating that the IDS filed 01-03-08 fails to comply with the rules because applicants do not give a reasonable reason for the delay in filing. Applicants were not attempting to file the IDS but, rather, were providing a copy of the IDS which was filed and scanned into the PTO records in May of 2006 but never initialed and returned to Applicants by the Examiner.

I hereby certify that this correspondence is being electronically submitted to the United States Patent and Trademark Office on February 25, 2008.

Diane Paull
(Name of Person Mailing Paper)

Diane Paull
Signature

02/25/2008
Date

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Applicants respectfully request that the Examiner initial and return the attached copy of Form PTO/SB/08a originally submitted May 3, 2006. A copy of the return receipt postcard date-stamped by the PTO is also enclosed for verification.

Respectfully submitted,

THE WEBB LAW FIRM

By



Kent E. Baldauf
Registration No. 25,826
Attorney for Applicants
700 Koppers Building
436 Seventh Avenue
Pittsburgh, Pennsylvania 15219
Telephone: 412-471-8815
Facsimile: 412-471-4094

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Substitute for form 1449A/PTO				Complete if Known	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(Use as many sheets as necessary)</i>				Application Number	10/525,996
				Filing Date	Feb. 28, 2005
				First Named Inventor	Hideo SENOO
				Art Unit	2811
				Examiner Name	Cuong Quang Nguyen
Sheet	1	of	1	Attorney Docket Number	1217-050618

U.S. PATENT DOCUMENTS							
Examiner Initials*	Cite No. ¹	Document Number			Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number - Kind Code ² (if known)					
		US-	5,637,395	B1	06-10-1997	Uemura et al.	
		US-	6,910,403	B1	06-28-2005	Ishikawa et al.	
		US-					
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FOREIGN PATENT DOCUMENTS							
Examiner Initials*	Cite No. ¹	Foreign Patent Document		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁶
		Country Code ³	Number ⁴ Kind Code ⁵ (if known)				
		JP(1985)	60-223139 A	11-07-1985	Nitto Electric Ind. Co.	English Abstract attached	
		JP(1993)	5-032946 A	02-09-1993	Lintec Corp.	English Abstract attached	
		JP(1996)	8-027239 A	01-30-1996	Lintec Corp.	English Abstract attached	
		JP(2002)	2005-057208 A	02-22-2002	Nitto Denko Corp.	English Abstract attached	
		JP(2003)	2003-129011 A	05-08-2003	Lintec Corp.	English Abstract attached	
		JP(2003)	2003-261842 A	09-19-2003	Lintec Corp.	English Abstract attached	

Examiner Signature	Date Considered
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. ¹ Applicant's unique citation designation number (optional). ² See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

This collection of information is required by 37 CFR 1.97 and 1.98. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

If you need assistance in completing the form, call 1-800-PTO-9199 and select option 2

The dating stamp of the Patent Office on this card will be taken as an indication that the accompanying paper was filed.

Applicants: Hideo Senoo et al.

Appl. No. 10/525,996

Paper dated May 3, 2006

Atty's File No. 1217-050618

Amount of Check N/A

KEB/dp

{W0227140.1}

In re Patent Application entitled
"Protective Structure of Semiconductor
Wafer, Method for Protecting..."

Transmittal Form PTO/SB/21;
Information Disclosure Statement
(1 p.-in dupl.);
Form PTO/SB/08A (1 p.); and
copies of Japanese references
with English Abstract attached

